

### 150V N-Channel Enhancement Mode MOSFET

Voltage 150 V Current 26 A

### **Features**

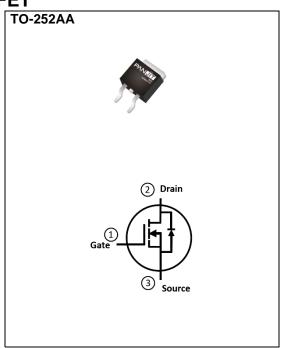
- RDS(ON), VGS@10V, ID@10A<49 $m\Omega$
- RDS(ON), VGS@7V, ID@6A< $54m\Omega$
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

### **Mechanical Data**

• Case: TO-252AA Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.3217 grams



### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	150	V	
Gate-Source Voltage		V <sub>GS</sub>	±20	V	
Continuous Drain Current <sup>(Note 3)</sup>	T <sub>C</sub> =25°C		26		
	T <sub>C</sub> =100°C	l <sub>D</sub>	18	Α	
Pulsed Drain Current(Note 1)	Tc=25°C	I <sub>DM</sub>	52		
Power Dissipation	Tc=25°C	D-	83	W	
	T <sub>C</sub> =100°C	Po	42		
Continuous Drain Current(Note 4)	T <sub>A</sub> =25°C		4.9	А	
	T <sub>A</sub> =70°C	l <sub>D</sub>	4.1		
Power Dissipation	T <sub>A</sub> =25°C	Po	3	W	
	T <sub>A</sub> =70°C		2.1		
Single Pulse Avalanche Current(Note 5)		las	24.5	Α	
Single Pulse Avalanche Energy <sup>(Note 5)</sup>		Eas	55	mJ	
Operating Junction and Storage Temperature Range		$T_{J}$ , $T_{STG}$	-55~175	°C	
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	$R_{ heta JC}$	1.8	°C/W	
	Junction to Ambient	$R_{\theta JA}$	50		



### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	150	-	ı		
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA		3	4	V	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	ı	39.5	49	mΩ	
		V <sub>GS</sub> =7V, I <sub>D</sub> =6A	-	41.5	54		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =150V, V <sub>GS</sub> =0V	-	-	1	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA	
Dynamic <sup>(Note 6)</sup>							
Total Gate Charge	Qg	V <sub>DS</sub> =75V, I <sub>D</sub> =10A,	ı	22	29	nC	
Gate-Source Charge	Q <sub>gs</sub>		ı	7	ı		
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	6	-		
Input Capacitance	Ciss	.,, .,	-	1116	1450	pF	
Output Capacitance	Coss	V <sub>DS</sub> =75V, V <sub>GS</sub> =0V, f=1MHz	-	81	142		
Reverse Transfer Capacitance	Crss	I=IIVIMZ	ı	23	ı		
Gate resistance	Rg	f=1MHz	ı	0.8	ı	Ω	
Turn-On Delay Time	td <sub>(on)</sub>		-	8.4	-		
Turn-On Rise Time	tr	V <sub>DS</sub> =75V, I <sub>D</sub> =10A,	ı	14	ı	ns	
Turn-Off Delay Time	td <sub>(off)</sub>	$V_{GS}=10V, R_{G}=3\Omega$	ı	17	ı		
Turn-Off Fall Time	tf	(100 2)	-	11	ı		
Drain-Source Diode							
Diode Forward Current	Is	T 05°0	ı	-	26		
Pulsed Diode Forward Current	I <sub>SM</sub>	T <sub>C</sub> =25°C	1	-	52	А	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V	-	0.9	1.3	V	
Reverse Recovery Time	Trr	V <sub>DD</sub> =75V,V <sub>GS</sub> =0V	ı	58	1	ns	
Reverse Recovery Charge	Qrr	Is=20A,dIs/dt=100A/us	-	90	-	nC	

#### NOTES:

- 1. Pulse width<a></a>100us, Duty cycle<a></a>2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an R<sub>0JC</sub>=1.8°C/W.
- 4. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. EAS is calculated based on the condition of L=1mH, IAS=10.5A, VDD=30V, VGS=10V. 100% test at L=0.1mH, IAS=24.5A in production.
- 6. Guaranteed by design, not subject to production testing.



#### **TYPICAL CHARACTERISTIC CURVES**

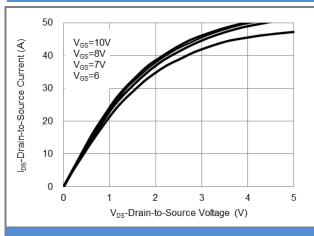


Fig.1 On-Region Characteristics

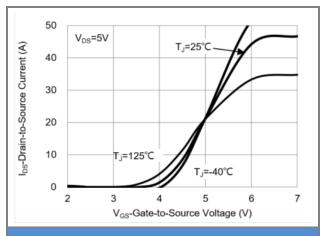


Fig.2 Transfer Characteristics

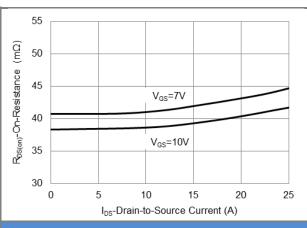


Fig.3 On-Resistance vs. Drain Current

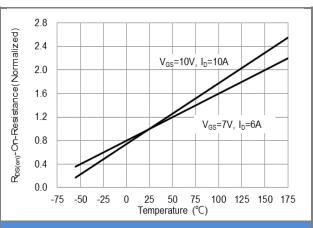
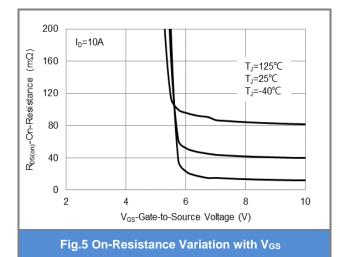


Fig.4 On-Resistance vs. Junction temperature



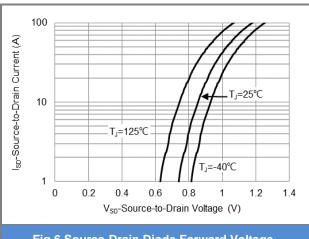


Fig.6 Source-Drain Diode Forward Voltage



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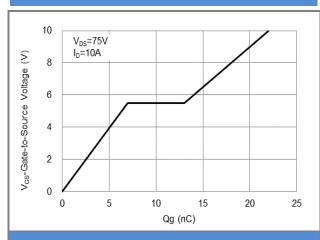


Fig.7 Gate-Charge Characteristics

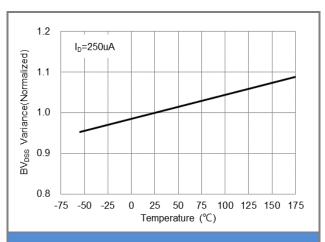


Fig.8 Breakdown Voltage Variation vs. Temperature

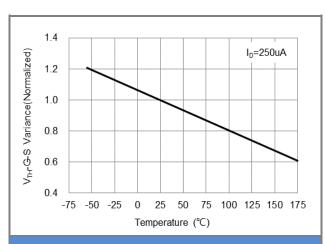


Fig.9 Threshold Voltage Variation with Temperature

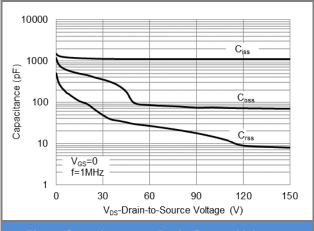
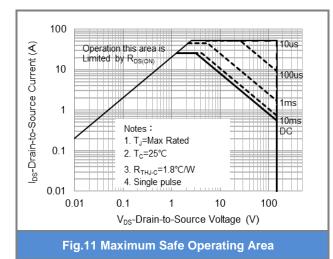
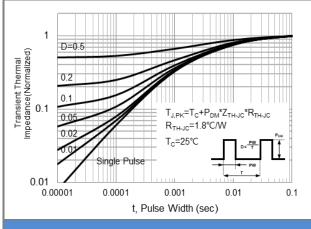


Fig.10 Capacitance vs. Drain-Source Voltage





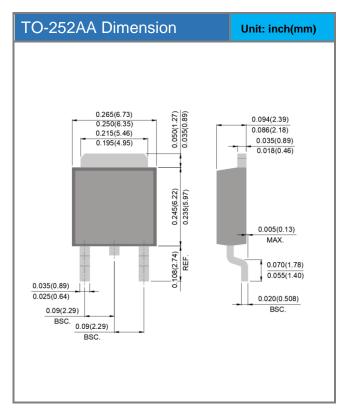
**Fig.12 Normalized Transient Thermal Impedance** 

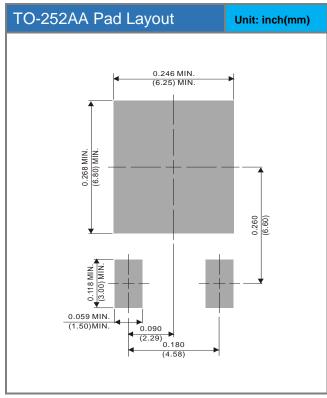


### **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking	
PJD30N15S-AU	TO-252AA	3K pcs / 13" reel	D30N15S	

### **Packaging Information & Mounting Pad Layout**







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